

SEMICON West 2009

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This product guide will be updated on a yearly basis. If you have suggestions for additional products not mentioned above, please contact SEMICON West Show Management at semiconwest@semi.org.

Note: Newly added categories to SEMICON West 2009 are further highlighted in yellow.

Note: Revised category names to SEMICON West 2009 are highlighted in blue.

DEVICE MANUFACTURERS

- 010-00 **Semiconductors (IC or Discrete Device manufacturing / IDM)**
- 011-00 **Wafer Fab Foundry Services Provider**
- 012-00 **Other Contract Manufacturing Services**
- 012-01 Contractor Manufacturing Services - Packaging; Assembly; Test - Back End
- 012-07 Contract Manufacturing Services - Component Assembly; Sub-assembly
- 012-11 Contract Manufacturing Services - Flat Panel Display (FPD)
- 012-13 Contract Manufacturing Services - Solar cells; Photovoltaic
- 013-00 **Fabless Houses**
- 014-00 **Micro Electro Mechanical Systems (MEMS); Micro Machines**
- 015-00 **Flat Panel Display (FPD); Liquid Crystal Display (LCD)**
- 016-00 **Optoelectronics; Photonics**
- 017-00 **Passive Components**
- 018-00 **Photovoltaic**
- 018-01 PV: Cells
- 018-02 PV: Modules
- 018-03 PV: Stand-Alone Systems
- 018-04 PV: Building-Integrated Solutions (BIPV)
- 018A-00 **Solar Thermal**
- 018B-00 **Solar Architecture**
- 019-00 **Nanotechnology**
- 019-01 **Solar Thermal**
- 019-02 **Solar Architecture for Solar Thermal**

EQUIPMENT MANUFACTURERS

Assembly & Packaging Equipment

- 021-01 Backgrind; Slicing; Lapping; Polishing Equipment
- 021-04 Ball Placement; Attach Systems
- 021-07 Base Loader Systems
- 021-10 Cleaning; Washing Equipment for Assembly & Packaging
- 021-13 Cut & Down Set; Trim; Form Equipment
- 021-16 Deflashing; Degating Tools
- 021-19 Device Handling; Feeding Systems
- 021-22 Dicing; Sawing; Scribing; Separation Equipment
- 021-25 Die Bonding; Attach Equipment
- 021-28 Die Removal Equipment
- 021-31 Die Sorter; Pick & Place; Flip Chip Placement Systems
- 021-34 Dispensing Systems
- 021-38 Hot Embossing System
- 021-40 Lead Finishing; Straightening Equipment

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- 021-43 Lead Frame Taping Systems
- 021-46 Lithography Systems for Wafer Level Packaging; Bumping; 3D Interconnect Aligners
- 021-49 Marking; Imprinting; Labeling Equipment
- 021-52 Molding; Encapsulation; Decapsulation Equipment
- 021-55 Package Handling; Conveying Equipment
- 021-58 Package Simulation; Characterization Equipment
- 021-63 Plating; Electro Chemical Plating for device assembly
- 021-64 Printing Equipment; Screen-printing; Alignment ; Film Printing
- 021-70 PROM; Memory Programmer Equipment
- 021-73 Solder Reflow; Soldering & Brazing Equipment

- 021-76 Tape Automated Bonding (TAB); Bumped Tape Automated Bonding (BTAB) Equipment
- 021-78 Wafer Level Bonders
- 021-79 Wafer Mount; Taping Equipment
- 021-82 Wire Bonding Equipment

- Flat Panel Display Manufacturing Equipment**
- 022-10 Alignment Film Coating Equipment
- 022-01 Anodic Oxidation Equipment
- 022-07 Color Pattern Processing Equipment
- 022-25 Cullet Removal Equipment
- 022-26 Laser Treatment; Cutting Systems for Panels & Photocells
- 022-28 Liquid Crystal Injection or Filling Equipment
- 022-04 Low Pressure Plasma Spray (LPPS) Equipment
- 022-37 Luminous Layer Patterning and Sealing Equipment
- 022-22 Panel Alignment; Cell Assembly Equipment
- 022-34 Polarizer Sticking Equipment
- 022-19 Rubbing Equipment
- 022-31 Scribe and Break Equipment
- 022-16 Seal Patterning Equipment
- 022-13 Spacer Spraying Equipment

- Inspection & Measurement Products**
- 023-01 Acoustic Spectroscopy; Electron Spectroscopy for Chemical Analysis (ESCA); Ultrasonic; Acoustical Microscopes
- 023-04 Air Velocity (VA) Humidity and Moisture Sensing
- 023-05 Centrifuges
- 023-07 Chromatograph
- 023-19 Instruments; Bench Top Test
- 023-16 CV (capacitance-to-voltage) Probe systems
- 023-22 Defect; Particle; Bump; Contamination Detection, Review or Inspection
- 023-13 Die Inspection; Die Shear
- 023-15 Fiber Optic Inspection Instruments
- 023-28 Film Thickness; Thickness; Uniformity Measurement; Ellipsometer
- 023-31 Wafer; Substrate Metrology; Topology; Nanotopography; Flatness Measurement; Crystalline Orientation
- 023-32 Flat; Notch Finding System
- 023-35 Leak Detection Systems - Vacuum or Gas

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- 023-37 Line Width; Critical Dimension (CD) Measurement
- 023-40 Microscopes: Atomic Force Microscopes (AFM)
- 023-43 Microscopes: Confocal Scanning Microscope; 3-D Video Microscopes
- 023-46 Microscopes: Optical Microscopes
- 023-49 Microscopes: Scanning Electron Microscope (SEM); Focused Ion Beam (FIB), Transmission Electron Microscope (TEM)
- 023-52 Overlay Measurement
- 023-55 Package Inspection; Lead Scanners
- 023-61 Plate Inspection Equipment
- 023-62 Resistivity Measurement; 4 point probe; Sheet resistance
- 023-34 Spectrometers; Fourier Transform Infrared (FTIR); Attenuated Total Reflectance FTIR (ATR-FTIR); Auger Electron (AES); SIMS
- 023-36 Stress; Refractive Index; Reflectivity & Conductivity Measurement
- 023-58 Particle Monitors; Analyzers - Airborne or Liquid
- 023-65 Thermal Sensing, Measurement, Analysis
- 023-70 Weight measurement; precision scales
- 023-10 Wire Bonding Inspection; Test
- 023-67 X-ray; XRF; 3-D X-Ray; LEXES Systems

Wafer Processing Equipment

- 024-01 Bumping Systems
- 024-04 CMP
- 024-07 Cleaning; Washing Equipment for Assembly & Packaging
- 024-10 Coat/Develop/Resist Processing Track
- 024-13 Crystal Growing & Machining
- 024-16 Deposition; (CVD, PVD, ALD, Plating)
- 024-28 Epitaxy Equipment
- 024-31 Etching/Stripping/Ashing
- 024-43 Ion Implantation
- 024-46 Lithography/Exposure
- 024-22 Thermal Processing
- 024-55 Transfer Systems for Wafer Reticles
- 024-58 Wafer Identification/Marking

Test Equipment

- 025-01 Burn-In Systems
- 025-04 Burn-In Accessory Systems
- 025-07 Circuit Repair; Design Modification; Redundant Memory Repair; Mask Repair Systems
- 025-10 Discrete Component Test Systems
- 025-11 ESD; EMS and Latch-up Systems
- 025-13 Failure Analysis Systems
- 025-16 FPD Test; Measurement; Repair Equipment
- 025-19 Functional Test Systems
- 025-22 Handlers; Positioner Systems
- 025-25 Linear Test Systems
- 025-28 Logic Test Systems
- 025-31 Memory Test Systems

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- 025-34 Optical Test Systems
- 025-37 Package Test Systems
- 025-40 Parametric Test Systems
- 025-42 Printed Circuit Board; Wire Board (PCB or PWB) Test and Repair
- 025-43 Probing Equipment incl. Analytical; Circuit; Manual; E-Beam; Optical; Wafer Probers
- 025-44 Probe Card Maintenance and Analysis Systems
- 025-46 System on a Chip (SOC); Mixed Signal Test Systems
- 025-49 Environmental Stress Systems - Temperature; Humidity; Pressure; HAST
- 025-50 Test Contactor Cleaning; Conditioning Systems
- 025-52 Test Head Manipulators and Docking Stations
- 025-55 Wireless, non-contact Test Systems
- Other Equipment**
- 026-01 Cutting; Drilling; Laser ablation; Beveling Equipment
- 026-04 Lamination; Sheet Laminating Equipment
- 026-13 Repair; Rework Equipment
- 026-16 Sealing; Bagging; Packing Equipment
- 026-19 Space simulation; Vacuum chambers
- 026-25 Vacuum drying & out gassing Systems
- 026-30 Vibration Isolation Systems
- 026-31 Vision; ID; Bar Code Systems
- 026-34 Welding Equipment
- 026-37 Heating; Annealing; Curing Equipment - Furnaces; Conveyors; Ovens; Test Chambers; Heat Treating
- Nanotechnology Equipment or Tools**
- 027-00 Equipment, Nanotechnology
- Solid State Lighting**
- 027A-00 Equipment, Solid State Lighting
- MEMS Equipment**
- 028-01 Deep RIE etching; Dry Etching
- 028-05 Double sided mask aligner
- 028-09 Wafer Level Bonders
- Photovoltaic Equipment**
- 029-00 PV Equipment
- 029-02 PV Equipment: Cells
- 029-03 PV Equipment: Modules
- 029-04 PV Equipment: Thin film
- 029-01 PV Equipment: Wafers
- 029-05 PV Equipment: Integration Automation
- 029-06 PV Equipment: Inspection and Metrology
- 029-07 PV Equipment: Other

MATERIALS MANUFACTURERS

Assembly & Packaging Materials

- 031-01 Adhesives; Epoxies; Die Attach Compounds; Under fill Materials; Conductive & Non-Conductive

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- 031-04 Bonding; Interconnect Materials - Wire; Ribbon; Tape; Capillaries & Tools
 - 031-12 Thermal Interface Materials; Heat Sinks
 - 031-13 Lead Frames & Headers: Etched; Stamped
 - 031-16 Marking ink
 - 031-19 Molding; Encapsulation; Potting; Resin Materials
 - 031-22 Package Substrates; Laminate; Film based
 - 031-25 Packages; Ceramic and Other High Temp Compounds
 - 031-28 Packages; Plastic
 - 031-31 Preforms; Lids
 - 031-34 Printed Circuit Boards (PCB); Printed Wire Boards (PWB)
(incl. Laminate; Multilayer; Ceramic ; High Temp Circuit Boards)
 - 031-37 Printing Masks; Screens
 - 031-40 Scribe Tools; Saw or Dicing Blades and Accessories
 - 031-43 Solder; Solder Balls and other Soldering Materials
 - 031-49 Tape Automated Bonding (TAB) Accessories
 - 031-52 Thick Film Pastes; Materials
 - 031-55 Thin Film; Dielectric Film Materials
- Chemicals & Solids**
- 032-01 Acids; Etchants
 - 032-04 Buffers; Alkalis; Bases
 - 032-07 Cleaning Chemicals; Solvents; Strippers
 - 032-10 DI; UP Water
 - 032-13 Dopants; liquid or solid
 - 032-19 Photo Resist; Developers & Ancillaries (incl. Adhesion promoter (HMDS); Primer; Anti-Reflective Coating (ARC); BARC; TARC)
 - 032-22 Spin on glass material
 - 032-25 Solids
 - 032-31 Surface protection material; coatings
 - 032-28 Other Specialty Chemicals
- Gases**
- 033-13 Analytical Instrumentation Mixtures
 - 033-16 Dopant Gases
 - 033-19 Environmental Compliance Mixtures
 - 033-22 Etchant Gases
 - 033-04 Fuel Gases
 - 033-25 Laser Gas Mixtures
 - 033-07 Pure & Bulk Gases
 - 033-10 Rare; Noble Gases
 - 033-28 Reactant Gases
 - 033-31 Silicon Precursor Gas
 - 033-34 Other Specialty; Mixed Gas
- Flat Panel Display Materials**
- 034-01 Alignment Film Materials
 - 034-04 Color Filter Materials
 - 034-07 End-Sealing Material
 - 034-10 Glass Plates for FPD

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- 034-13 Liquid Crystal Materials
- 034-16 Polarizer Materials
- 034-19 Spacer Materials

Mask / Mask Making Materials

- 035-01 Mask and Reticle Handling Products
- 035-04 Mask plate blanks; Glass
- 035-07 Pellicles; Mounting Fixtures
- 035-10 Plate or Pellicle Repair & Materials
- 035-13 Transfer lithography masks; Polymer masks; templates (for Nanoimprint)

Process Materials

- 036-01 CMP; Grind; Lap; Polish; Abrasive materials
- 036-04 Deposition Supplies
- 036-07 Process Chamber Components; Graphite; Carbon Fiber Carbon (CFC); Pyrolytic Boron Nitride (PBN)
- 036-10 Ingots
- 036-13 Photo Masks, Finished or Patterned
- 036-16 Plating Materials
- 036-19 Plasma; Ion Sources
- 036-22 Polysilicon or granular polycrystalline silicon; Crystal growing Material
- 036-25 Quartz ware (Silicon Carbide, Fused Quartz Glass, Sapphire), Ceramic & Oxide Ceramic Fixtures

Wafers and Substrate

- 037-01 Compound Semiconductor substrates (GaAs on Silicon; GaN; InP; SiGe, etc.)
- 037-02 Diamond substrates
- 037-13 Epitaxial; Epi; Gettered; Internal Gettered Wafers
- 037-04 Gallium Arsenide (GaAs); Sapphire Substrates
- 037-19 Prime; Polished; Mirrored Wafers
- 037-09 Silicon on Insulator (SOI); Silicon on Sapphire (SOS); Silicon Carbide;
- 037-16 Strained silicon; Engineered Substrates
- 037-20 solar cell substrates; crystalline silicon (c-Si); thin film
- 037-22 Test; Monitor Wafers; Reclaim or Virgin
- 037-25 Thin & Thick film substrates for MEMS

Test Materials

- 038-16 Burn-In Boards; Performance Boards (incl. Low; High Temp and Ceramic)
- 038-01 Probe Cards; DUT boards and other probing accessories (incl Ceramic and Special Purpose Probe Cards)
- 038-13 Test Sockets; Contactors and Contact accessories
- 038-28 Structural Circuits; Test; Thermal Fixturing

Nanotechnology Materials

- 039-00 Nanotechnology Materials
- 039A-30 Photovoltaic Materials
- 039-01 Wafer materials
- 039-02 Cell Materials
- 039-03 Module Materials
- 039-04 Thin Film Materials

PV Materials

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- 039A-01 PV Materials: Consumables (Past, Wires, Etc.)
- 039A-02 PV Materials: Gases and Liquid Chemicals
- 039A-03 PV Materials: Solar Glass, Encapsulation
- 039A-04 PV Materials: Ingots, Wafers
- 039A-05 PV Materials: Feedstock: Polysilicon, UMG, etc.
- 039A-06 PV Materials: Other

Other Materials

- 039B-00 Other Materials

SUB-SYSTEMS OR COMPONENTS OR PARTS

Sub-systems

- 041-10 Cameras - Still; CCD; Video & Monitors
- 041-17 Computer ; Control ; Communication ; Data Acquisition Systems
- 041-31 Electron tube & Ion Beam Apparatus & Sources
- 041-27 Process Monitoring systems
- 041-38 Exposure; Illumination Sources - Laser; Lamp; X-ray & other
- 041-40 Gas; Liquid delivery panels as subsystems
- 041-42 Gear reducers; Gearheads; Geardrives
- 041-52 Handling; Transfer; Loading Systems; Lifting devices
- 041-59 Hydraulic Systems
- 041-55 Motion control systems; Servo control systems & Components
- 041-45 Optics; Lens Products; Auto-Focus Systems
- 041-62 Plasma Sources; Controls; Monitoring; Diagnosis
- 041-64 Pneumatic Systems; Pneumatic rotary spindles
- 041-66 Power Supplies; RF Generators; Converters; Electrical Conditioning
- 041-80 Pumps, for Fluids
- 041-73 Pumps, Vacuum
- 041-87 Temperature Sensing; Control; Recirculators; Chillers; Heat Exchangers
- 041-90 Ultrasonic Generators; Transducer and Monitoring Systems

Components, Parts & Accessories

- 045-01 Bearings; Shaft Collars
- 045-05 Chucks for Wafer and other Substrates
- 045-10 Computer Accessories; Peripherals; Upgrades; Service
- 045-17 Connectors; Plugs; Interconnects; Cable; Wire
- 045-20 Electronic Hardware; Fixtures and Supplies
- 045-22 Enclosures; Cabinets
- 045-43 Filters, Getters, Purifiers, Catalysts for Gases
- 045-45 Filters for Liquid; Oil
- 045-24 Fasteners; General Hardware
- 045-38 Flow Control Components - Valves; Meters; Gauges; Regulators; MFC's
- 045-52 Gaskets; Seals; O rings; Elastomers; Resins
- 045-53 Heating elements; coils; insulation; vestibule blocks and other Furnace components
- 045-55 Indicator Status Lights
- 045-58 Lamps for Lithography
- 045-60 Lamps (non Lithography), all type UV; LED and other
- 045-62 Magnetic Components; Heads
- 045-66 Motors; Fans; Electric Rotary Spindles

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- 045-57 Piezo Electronic Components
- 045-59 Pipe; Tubing; Hose; Flanges; Connectors; Couplings; Plumbing Fittings
- 045-71 Raw Material & Custom components; Metal
- 045-69 Raw Material & Custom components; Plastic
- 045-73 Sealants; Adhesives; Finishes
- 045-80 Sensors
- 045-87 Vacuum Systems Components & Accessories (optical monitors; Sputtering target fixtures; lubricants; pump oils; etc.)
- 045-94 Windows

PV Systems

- 046-01 PV Systems: Inverters
- 046-02 PV Systems: Measurement and Control Technology
- 046-03 PV Systems: Chargers, Batteries
- 046-04 PV Systems: Stand Alone Systems

PV Components, Tracking, and Mounting Systems

- 047-01 PV Components: Cables, Connectors, Junction Boxes
- 047-02 PV Components: Tracking Systems
- 047-03 PV Components: Mounting Systems

FACTORY CONTROL & FACILITIES

Factory Control Automation/Facilities

- 051-13 Chemical; Pure Water; Fluid Handling; Storage; Supply Systems
- 051-16 Chemical; Pure Water; Fluid Monitoring & Control Systems
- 051-07 Data Collection; Building control systems
- 051-20 Electrical; Power Distribution
- 051-25 Emergency (fire) & Security Control Systems
- 051-34 Environmental; Utility Systems & Monitoring
- 051-28 Equipment Interface; Communication Protocols
- 051-43 Gas and Other Generation Systems
- 051-37 Gas Handling - Cabinets; Control; Supply Systems
- 051-40 Gas Monitoring Equipment; RGA's; TGO compliance
- 051-52 Logistics; Floor Control Systems
- 051-55 Process Controls
- 051-67 Waste Control; Effluent Management Systems (Fluid & Gas; Exhaust Conditioning; Scrubbers)

HVAC, Temperature, Humidity, Contamination Control

- 052-19 Clean Rooms
- 052-22 Contamination Control; HEPA Filtering Systems
- 052-46 HVAC; Temperature; Humidity Systems and Control

Material Handling Systems

- 053-49 Conveying; Material Handling Systems
- 053-10 Robotics; Transfer Systems
- 053-61 Static; ESD Control
- 053-65 Stockers; Storage, AMHS

SOFTWARE

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Manufacturing Operations Software

- 061-04 CAM or CIM - Computer Aided Manuf'g; Computer Integrated Manuf'g
- 061-07 Manufacturing Execution Software (MES)
- 061-11 Factory Automation; Cell Controller Software
- 061-19 Production Control software
- 061-22 Test Programs
- 061-25 Yield Mgmt; Process Control Software

Communication Software

- 062-13 Equipment Interface; Communication Protocols

Design Software

- 063-01 CAD - Computer Automated Design
- 063-10 EDA - Electronic Design Automation; Circuit Design

Simulation, Analysis, Modeling Software

- 064-10 Mask Making software & simulation
- 064-16 Simulation; Characterization; Verification Software
- 064-18 Statistical Analysis; Modeling; Cost of Ownership (CoO) Software

MANUFACTURING SERVICES OR CONSULTING (incl. Those Services or Consulting directly related to

Manufacturing Services

- 073-01 Burn-In Service
- 073-02 Building Maintenance
- 073-04 Calibration & Reference Standards
- 073-07 Certification; Compliance; Independent Laboratories
- 073-13 Color Filter Manufacturing
- 073-16 Failure Analysis and other Analytical Services
- 073-19 Deposition Service
- 073-21 Etch; Strip; Cleaning Service
- 073-22 Ion Implant Service
- 073-23 Laundry service; Cleanroom Garments and other
- 073-24 Lithography; Patterning service
- 073-25 Machine Shop; Fabrication Service
- 073-28 Micro Machining services (small hole drilling and milling)
- 073-31 Mask Making Fabrication and Repair
- 073-34 Measurement; Inspection Service
- 073-37 Parts Cleaning; Micro Contamination
- 073-40 Plating; Electro Polishing; Coating; Surface Treatment
- 073-43 Reclaim Services (Evaporation; sputtering source material; Precious metal reclaim; Scrap; Vacuum pump oil; Wafer reclaim)
- 073-46 Repair; Rebuild; Install Equipment; Maintenance Services; Spare Parts
- 073-49 Sawing; Lapping; Grinding; Polishing Service
- 073-52 Used; Rental Equipment; Inventory Reduction, Appraisal - Brokers; Resellers
- 073-55 Wafer Bumping Service
- 073-58 Welding; specialty welding services

Manufacturing Services or Consulting

- 074-02 Assembly
- 074-05 Automation & Robotics

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- 074-08 CAD; CAM; CIM
- 074-11 Circuit Design; Electronic Design Services (EDS); System Level Design (SLD)
- 074-14 Clean Room; Contamination Control
- 074-17 Environmental, Health & Safety
- 074-20 Equipment; Hardware; Product Design, Integration and Manufacturing

- 074-23 Facilities; Building Environmental Systems Design & Monitoring; Alternative Energy Solutions
- 074-26 Facility Design; Construction; Architectural
- 074-29 Factory; Industrial Control; Utilization & Automation
- 074-32 Flat Panel Display (FPD) Design & Manufacturing
- 074-35 Manufacturing Process Support and Development
- 074-36 NanoTechnology Intellectual Property Development; Research
- 074-38 Package Simulation; Characterization Services
- 074-41 Package Materials; Interconnect; Subcomponent; Subassembly Design Services
- 074-44 Product Development; Software Design; Product Lifecycle Management
- 074-47 Software Programming; Software Development
- 074-50 Static; ESD Testing & Control Services
- 074-53 Technical Intelligence; Reverse Engineering
- 074-56 Test Services or Consulting
- 074-59 Wafer Fab Operations and Design
- 074-62 Wafer Handling
- 074-65 Waste Control; Disposal Design

BUSINESS SERVICES OR CONSULTING (incl. Those Services or Consulting NOT directly related to

Business Services or Consulting

- 081-19 Government Advocacy; Regulation; Economic Development Agencies
- 081-22 Insurance
- 081-23 IT; Data Processing Services
- 081-28 Legal Services
- 081-31 Libraries
- 081-34 Market Studies; Market Research Organizations
- 081-37 Marketing or Sales Consultants
- 081-39 Operations; Management Consulting
- 081-38 Personnel Services; Employee Assistance; Recruiters; HR
- 081-41 Property Management ; Real Estate
- 081-42 Public Relations
- 081-43 Publications or Magazines; Printing
- 081-44 Purchasing; Procurement; Materials; Supply Chain Management Services
- 081-52 Sales; Manufacturers Representation or Distributors
- 081-65 Trade Shows; Conference; Symposium Coordinators
- 081-61 Web hosting; Design; Internet consulting; Systems Integration

Associations

- 082-01 Associations; Trade or Industrial
- 082-40 Professional Societies

Financial Services

- 083-04 Banks

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- 083-16 Financial; Auditing; Tax Services
- 083-20 Investor Relations
- 083-25 Leasing; Asset Utilization
- 083-58 Venture Capital
- Distribution and Logistics**
- 084-01 Crating; Packaging
- 084-04 Customs Clearance; Import/ Export; Freight Forwarders
- 084-07 Distribution, Warehousing, 3rd Party Logistics Providers (3PL)
- 084-10 Transportation; Rigging
- Educational; Research Institutions**
- 085-10 Education; Research Institutions (For-Profit); Vocational Training
- 085-13 Education; Research Institutions (Non Profit); Academia; Schools
- PV Services**
- 086-01 PV Services: Education, Training
- 086-02 PV Services: Financing, Promotion
- 086-03 PV Services: Organization, Association
- 086-04 PV Services: Research & Development
- 086-05 PV Services: Testing Institutes

SUPPORT PRODUCTS (incl. consumable materials)

- Support Products**
- 091-00 **Analytical Standards; Calibrators**
- 092-00 **Clean Room Supplies; Cleaning Supplies**
- 093-00 **Device; Wafer; Display Panel Handling Products**
- 094-00 **Furniture; Storage; Cabinets**
- 095-00 **Garments ; Apparel**
- 096-00 **Laboratory Apparatus and Supplies**
- 097-00 **Safety**
- 098-00 **Tools**

- 100 **CONSUMER OF ELECTRONICS or DISPLAYS**
(incl. Aerospace; Defense; Automotive; Communications; Networking; Computer; Consumer; etc.)

- 999 **OTHER; write in _____**